# Product Preview

# **LCD Panel EMI Reduction IC**

## **Product Description**

The P2042A is a versatile spread spectrum frequency modulator designed specifically for digital flat panel applications. The P2042A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of down stream clock and data dependent signals. The P2042A allows significant system cost savings by reducing the number of circuit board layers, ferrite beads, shielding, and other passive components that are traditionally required to pass EMI regulations.

The P2042A uses the most efficient and optimized modulation profile approved by the FCC and is implemented in a proprietary all digital method.

The P2042A modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called 'spread spectrum clock generation'.

#### **Applications**

The P2042A is targeted towards digital flat panel applications for notebook PCs, palm-size PCs, office automation equipments, and LCD monitors.

#### **Features**

- FCC Approved Method of EMI Attenuation
- Provides up to 15 dB of EMI Suppression
- Generates a Low EMI Spread Spectrum Clock of the Input Frequency
- Input Frequency Range: 30 MHz to 110 MHz
- Optimized for 32.5 MHz, 54 MHz, 65 MHz and 108 MHz Pixel Clock Frequencies
- Internal Loop Filter Minimizes External Components and Board Space
- Eight Selectable High Spread Ranges up to ±1.9%
- SSON# Control Pin for Spread Spectrum Enable and Disable Options
- Low Cycle-to-Cycle Jitter
- 3.3 V  $\pm$  0.3 V Operating Range
- Low Power CMOS Design
- Supports Most Mobile Graphic Accelerator and LCD Timing Controller Specifications
- Available in 8-pin SOIC and TSSOP Packages
- These are Pb-Free Devices

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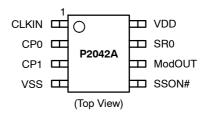
CASE 751BD





TSSOP-8 T SUFFIX CASE 948AL

#### **PIN CONFIGURATION**



#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

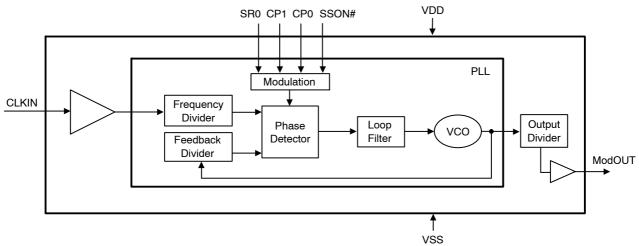


Figure 1. Block Diagram

**Table 1. ABSOLUTE MAXIMUM RATINGS** 

| Symbol   | Parameter   | Rating       | Unit |
|--|---|--------------|------|
| VDD, V <sub>IN</sub>                               | Voltage on any pin with respect to Ground             | -0.5 to +4.6 | V    |
| T <sub>STG</sub>                                   | Storage temperature                                   | -65 to +125  | °C   |
| T <sub>A</sub>                                     | Operating temperature                                 | -40 to +85   | °C   |
| T <sub>s</sub> Max. Soldering Temperature (10 sec) |   | 260          | °C   |
| TJ   | T <sub>J</sub> Junction Temperature                   |              | °C   |
| $T_DV$   | Static Discharge Voltage (As per JEDEC STD22- A114-B) | 2            | KV   |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

**Table 2. PIN DESCRIPTION** 

| Pin# | Pin Name | Туре | Description   |  |
|------|----------|------|---|--|
| 1    | CLKIN    | I    | External reference frequency input. Connect to externally generated reference signal.   |  |
| 2    | CP0      | I    | Digital logic input used to select charge pump current. This pin has an internal pull-up resistor. Refer to <i>Modulation Selection</i> Table.  |  |
| 3    | CP1      | I    | Digital logic input used to select charge pump current. This pin has an internal pull-up resistor. Refer to <i>Modulation Selection</i> Table.  |  |
| 4    | VSS      | Р    | Ground to entire chip. Connect to system ground.  |  |
| 5    | SSON#    | I    | Digital logic input used to enable Spread Spectrum function (Active LOW). Spread Spectrum function enabled when LOW, disabled when HIGH.  This pin has an internal pull-low resistor. |  |
| 6    | ModOUT   | 0    | Spread spectrum clock output.   |  |
| 7    | SR0      | ļ    | Digital logic input used to select Spreading Range. This pin has an internal pull-up resistor.  |  |
| 8    | VDD      | Р    | Power supply for the entire chip  |  |

**Table 3. MODULATION SELECTION** 

|     |     |     | Spreading Range (±%) |        |        |        |         |                        |
|-----|-----|-----|----------------------|--------|--------|--------|---------|------------------------|
| CP0 | CP1 | SR0 | 32.5 MHz             | 54 MHz | 65 MHz | 81 MHz | 108 MHz | Modulation Rate (KHz)  |
| 0   | 0   | 0   | 0.56                 | 1.05   | 1.00   | 0.98   | 0.80    |                        |
| 0   | 0   | 1   | 1.94                 | 1.68   | 1.56   | 1.48   | 1.22    |                        |
| 0   | 1   | 0   | 1.36                 | 1.05   | 1.00   | 0.92   | 0.67    |                        |
| 0   | 1   | 1   | 1.92                 | 1.68   | 1.56   | 1.48   | 1.06    | (FIN /40) * 62.49 KHz  |
| 1   | 0   | 0   | 1.24                 | 0.81   | 0.66   | 0.40   | 0.27    | (FIIV /40) * 02.49 KHZ |
| 1   | 0   | 1   | 1.91                 | 1.29   | 1.02   | 0.74   | 0.43    |                        |
| 1   | 1   | 0   | 0.91                 | 0.45   | 0.34   | 0.05   | 0.15    |                        |
| 1   | 1   | 1   | 1.47                 | 0.71   | 0.54   | 0.36   | 0.21    |                        |

#### **Spread Spectrum Selection**

The *Modulation Selection* Table defines the possible spread spectrum options. The optimal setting should minimize system EMI to the fullest without affecting system performance. The spreading is described as a percentage deviation of the center frequency. (Note: The center frequency is the frequency of the external reference input on CLKIN, pin1).

For example, P2042A is designed for high-resolution, flat panel applications and is able to support an XGA (1024 x

768) flat panel operating at 65 MHz (FIN) clock speed. A spreading selection of CP0 = 0, CP1 = 1 and SR0 = 0 provides a percentage deviation of  $\pm 1.00\%$  from  $F_{IN}$ . This results in the frequency on ModOUT being swept from 65.65 to 64.35 MHz at a modulation rate of 101.54 KHz. Refer to *Modulation Selection* Table. The example in the following illustration is a common EMI reduction method for a notebook LCD panel and has already been implemented by most of the leading OEM and mobile graphic accelerator manufacturers.

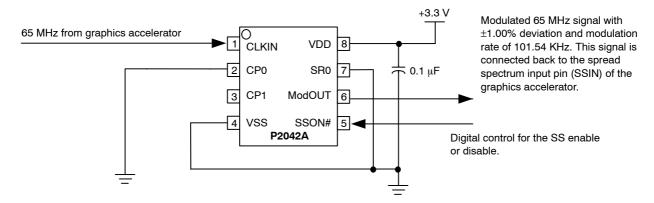


Figure 2. Application Schematic for Mobile LCD Graphics Controllers

**Table 4. OPERATING CONDITIONS** 

| Symbol         | Pa                    | Min                   | Тур   | Max | Unit  |       |      |
|----------------|-----------------------|-----------------------|-------|-----|-------|-------|------|
| VDD            | Supply Voltage        | with respect to Grour | 3.0   | 3.3 | 3.6   | V     |      |
| T <sub>A</sub> | Operating temperature | Commercial            |       | 0   |       | +70   | °C   |
|                |                       | Industrial            |       | -40 |       | +85   |      |
| $T_J$          | Junction temperature  | Commercial            | SOIC  |     |       | 82.39 | °C   |
|                |                       |                       | TSSOP |     |       | 79.8  |      |
|                |                       | Industrial            | SOIC  |     |       | 97.39 |      |
|                |                       |                       | TSSOP |     |       | 94.8  |      |
| $\theta_{JC}$  |                       | SOIC                  | •     |     | 156.5 |       | °C/W |
|                | -                     | TSSOP                 |       |     | 124   |       |      |

## Table 5. DC ELECTRICAL CHARACTERISTICS

| Symbol           | Parameter  | Min     | Тур  | Max     | Unit |
|------------------|--|---------|------|---------|------|
| $V_{IL}$         | Input low voltage  | VSS-0.3 |      | 0.8     | V    |
| V <sub>IH</sub>  | Input high voltage   | 2.0     |      | VDD+0.3 | V    |
| I <sub>IL</sub>  | Input low current (pull-up resistor on inputs CP0, CP1 and SR0)        |         |      | -35     | μΑ   |
| I <sub>IH</sub>  | Input high current (pull-down resistor on input SSON#)                 |         |      | 35      | μΑ   |
| V <sub>OL</sub>  | Output low voltage (V <sub>DD</sub> = 3.3 V, I <sub>OL</sub> = 20 mA)  |         |      | 0.4     | V    |
| V <sub>OH</sub>  | Output high voltage (V <sub>DD</sub> = 3.3 V, I <sub>OL</sub> = 20 mA) | 2.5     |      |         | V    |
| I <sub>DD</sub>  | Static supply current standby mode                                     |         | 0.6  |         | mA   |
| I <sub>CC</sub>  | Dynamic supply current (3.3 V and 10 pF loading)                       | 9       | 16   | 22      | mA   |
| $V_{DD}$         | Operating voltage  | 3.0     | 3.3  | 3.6     | V    |
| t <sub>ON</sub>  | Power-up time (first locked cycle after power up)                      |         | 0.18 |         | mS   |
| Z <sub>OUT</sub> | Clock output impedance   |         | 50   |         | Ω    |

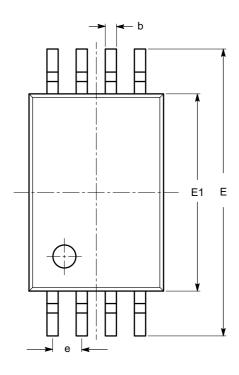
### **Table 6. AC ELECTRICAL CHARACTERISTICS**

| Symbol                   | Parameter                                     | Min | Тур | Max | Unit |
|--------------------------|---|-----|-----|-----|------|
| f <sub>IN</sub>          | Input frequency                               | 30  | 65  | 110 | MHz  |
| fout                     | Output frequency                              | 30  | 65  | 110 | MHz  |
| t <sub>LH</sub> (Note 1) | Output rise time (measured at 0.8 V to 2.0 V) | 0.7 | 0.9 | 1.1 | nS   |
| t <sub>HL</sub> (Note 1) | Output fall time (measured at 2.0 V to 0.8 V) | 0.6 | 0.8 | 1.0 | nS   |
| tuc                      | Jitter (cycle-to-cycle)                       |     |     | 360 | pS   |
| t <sub>D</sub>           | Output duty cycle                             | 45  | 50  | 55  | %    |

<sup>1.</sup> t<sub>LH</sub> and t<sub>HL</sub> are measured into a capacitive load of 15 pF.

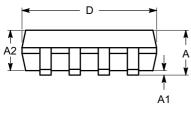
# PACKAGE DIMENSIONS

TSSOP8, 4.4x3 CASE 948AL-01 ISSUE O

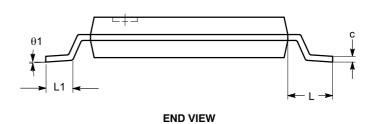


| SYMBOL | MIN      | NOM  | MAX  |  |  |
|--------|----------|------|------|--|--|
| Α      |          |      | 1.20 |  |  |
| A1     | 0.05     |      | 0.15 |  |  |
| A2     | 0.80     | 0.90 | 1.05 |  |  |
| b      | 0.19     |      | 0.30 |  |  |
| С      | 0.09     |      | 0.20 |  |  |
| D      | 2.90     | 3.00 | 3.10 |  |  |
| Е      | 6.30     | 6.40 | 6.50 |  |  |
| E1     | 4.30     | 4.40 | 4.50 |  |  |
| е      | 0.65 BSC |      |      |  |  |
| L      | 1.00 REF |      |      |  |  |
| L1     | 0.50     | 0.60 | 0.75 |  |  |
| θ      | 0°       |      | 8°   |  |  |





**SIDE VIEW** 

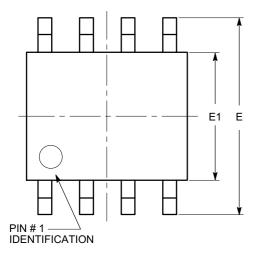


#### Notes:

- (1) All dimensions are in millimeters. Angles in degrees.(2) Complies with JEDEC MO-153.

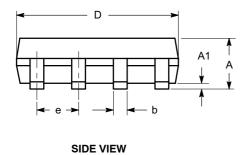
## **PACKAGE DIMENSIONS**

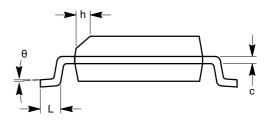
SOIC 8, 150 mils CASE 751BD-01 ISSUE O



| SYMBOL | MIN      | NOM | MAX  |  |  |
|--------|----------|-----|------|--|--|
| Α      | 1.35     |     | 1.75 |  |  |
| A1     | 0.10     |     | 0.25 |  |  |
| b      | 0.33     |     | 0.51 |  |  |
| С      | 0.19     |     | 0.25 |  |  |
| D      | 4.80     |     | 5.00 |  |  |
| E      | 5.80     |     | 6.20 |  |  |
| E1     | 3.80     |     | 4.00 |  |  |
| е      | 1.27 BSC |     |      |  |  |
| h      | 0.25     |     | 0.50 |  |  |
| L      | 0.40     |     | 1.27 |  |  |
| θ      | 0°       |     | 8°   |  |  |

**TOP VIEW** 





**END VIEW** 

## Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MS-012.

**Table 7. ORDERING INFORMATION** 

| Part Number          | Marking | Package Type                      | Temperature |
|----------------------|---------|-----------------------------------|-------------|
| P2042AF-08ST         | P2042AF | 8-Pin SOIC, TUBE, Pb Free         | Commercial  |
| P2042AF-08SR         | P2042AF | 8-Pin SOIC, TAPE & REEL, Pb Free  | Commercial  |
| P2042AF-08TT         | P2042AF | 8-Pin TSSOP, TUBE, Pb Free        | Commercial  |
| P2042AF-08TR         | P2042AF | 8-Pin TSSOP, TAPE & REEL, Pb Free | Commercial  |
| P2042AG-08ST         | P2042AG | 8-Pin SOIC, TUBE, Green           | Commercial  |
| P2042AG-08SR         | P2042AG | 8-Pin SOIC, TAPE & REEL, Green    | Commercial  |
| P2042AG-08TT         | P2042AG | 8-Pin TSSOP, TUBE, Green          | Commercial  |
| P2042AG-08TR         | P2042AG | 8-Pin TSSOP, TAPE & REEL, Green   | Commercial  |
| I2042AF-08ST         | I2042AF | 8-Pin SOIC, TUBE, Pb Free         | Industrial  |
| I2042AF-08SR         | I2042AF | 8-Pin SOIC, TAPE & REEL, Pb Free  | Industrial  |
| I2042AF-08TT         | I2042AF | 8-Pin TSSOP, TUBE, Pb Free        | Industrial  |
| I2042AF-08TR         | I2042AF | 8-Pin TSSOP, TAPE & REEL, Pb Free | Industrial  |
| I2042AG-08ST         | I2042AG | 8-Pin SOIC, TUBE, Green           | Industrial  |
| I2042AG-08SR         | I2042AG | 8-Pin SOIC, TAPE & REEL, Green    | Industrial  |
| I2042AG-08TT         | I2042AG | 8-Pin TSSOP, TUBE, Green          | Industrial  |
| I2042AG-08TR I2042AG |         | 8-Pin TSSOP, TAPE & REEL, Green   | Industrial  |

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